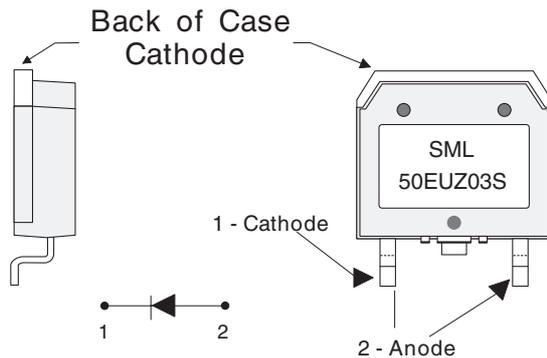


## Ultrafast Recovery Diode 300 Volt, 50Amp



See package outline for mechanical data and more details

### D<sup>3</sup> PAK Package

### Key Parameters

$V_R$	(max)	300V
$V_F$	(typ)	1.7V
$I_F$	(max)	50A
$t_{rr}$	(max)	40ns

### TECHNOLOGY

The planar passivated and enhanced ultrafast recovery diode features a triple charge control action utilising Semelab's Graded Buffer Zone technology combined with low emitter efficiency and local lifetime control techniques.

### BENEFITS

- Very fast recovery for low switching losses
- Ultra soft recovery with low EMI generation
- High dynamic ruggedness under all conditions
- Low temperature dependency
- Low on-state losses with positive temperature coefficient
- Stable blocking voltage and low leakage current
- Avalanche rated for high reliability circuit operation

### APPLICATIONS

- Freewheeling Diode for IGBTs and MOSFETs
- Uninterruptible Power Supplies UPS
- Switch Mode Power Supplies SMPS
- Inverse and Clamping Diode
- Snubber Diode
- Fast Switching Rectification

### ABSOLUTE MAXIMUM RATINGS ( $T_{case} = 25^\circ\text{C}$ unless otherwise stated)

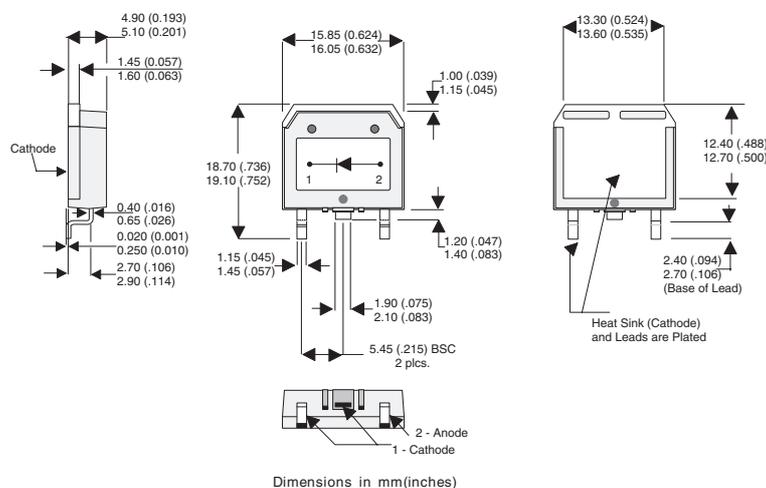
$V_{RRM}$	Peak Repetitive Reverse Voltage	300V
$V_R$	DC Reverse Blocking Voltage	300V
$I_{FAV}$	Average Forward Current @ $T_C = 85^\circ\text{C}$	50A
$I_{FSM(surge)}$	Repetitive Forward Current	125A
$I_{FS(surge)}$	Non-Repetitive Forward Current	500A
$P_D$	Power Dissipation @ $T_C = 85^\circ\text{C}$	90W
$W_{AVL}$	Avalanche Energy	30mJ
$T_J, T_{STG}$	Operating & Storage Junction Temperature	-55 to $150^\circ\text{C}$

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## ELECTRICAL CHARACTERISTICS ( $T_{case} = 25^{\circ}C$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>STATIC ELECTRICAL CHARACTERISTIC</b>					
$V_F^*$ Forward Voltage Drop	$I_F = 50A$ $T_j = 25^{\circ}C$		1.7	2.25	V
	$I_F = 50A$ $T_j = 125^{\circ}C$		1.8		
	$I_F = 25A$ $T_j = 25^{\circ}C$		1.4		
$I_R$ Leakage Current	$V_R = 300V$ $T_j = 25^{\circ}C$		0.75	300	$\mu A$
	$V_R = 300V$ $T_j = 125^{\circ}C$		0.5	3	mA
$C_T$ Junction Capacitance	$V_R = 200V$ $T_j = 25^{\circ}C$		74		pF
<b>DYNAMIC ELECTRICAL CHARACTERISTIC</b>					
$Q_{rr}$ Reverse Recovery Charge	$V_R = 200V$ $I_F = 50A$ $d_i / d_t = 600A/\mu s$ $T_J = 25^{\circ}C$		0.44		$\mu C$
$I_{rr}$ Reverse Recovery Current			16		A
$t_{rr}$ Reverse Recovery Time			55		nsec
$Q_{rr}$ Reverse Recovery Charge	$V_R = 200V$ $I_F = 50A$ $d_i / d_t = 600A/\mu s$ $T_J = 125^{\circ}C$		0.71		$\mu C$
$I_{rr}$ Reverse Recovery Current			22		A
$t_{rr}$ Reverse Recovery Time			66		nsec
$t_{rr}$ Reverse Recovery Time	$V_R = 50V$ $I_F = 1A$ $d_i / d_t = 100A/\mu s$ $T_J = 25^{\circ}C$		40		nsec
<b>THERMAL AND MECHANICAL CHARACTERISTICS</b>					
$R_{\theta jc}$ Junction to Case Thermal Resistance				0.93	$^{\circ}C/W$
$T_L$ Lead Temperature				300	$^{\circ}C$
$L_S$ Stray Inductance			10		nH

### D<sup>3</sup>PAK Package



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